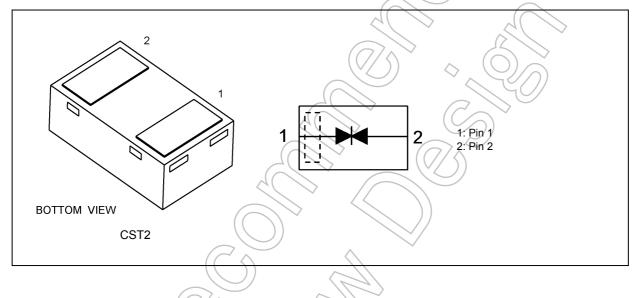
ESD Protection Diodes Silicon Epitaxial Planar

# DF2B12M1CT

#### 1. Applications

- ESD Protection
- Note: This product is designed for protection against electrostatic discharge (ESD) and is not intended for any other purpose, including, but not limited to, voltage regulation.

#### 2. Packaging and Internal Circuit



3. Absolute Maximum Ratings (Note) (Unless otherwise specified,  $T_a = 25^{\circ}$ C)

Characteristics	Symbol	Rating	Unit
Electrostatic discharge voltage (IEC61000-4-2)(Contact)	VESD	±8	kV
Junction temperature	Тj	150	°C
Storage temperature	T <sub>stg</sub>	-55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

I<sub>R</sub>: Reverse current V<sub>C</sub>: Clamp voltage IPP: Peak pulse current R<sub>DYN</sub>: Dynamic resistance

### 4. Electrical Characteristics (Unless otherwise specified, T<sub>a</sub> = 25°C)

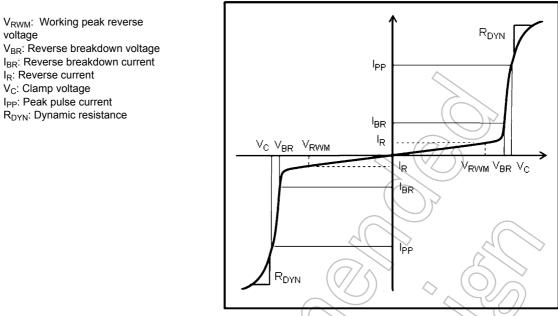


Fig. 4.1 Definitions of Electrical Characteristics

Symbol	Note	Test Condition	Min	Тур.	Max	Unit
V <sub>RWM</sub>			) - (	_	8	V
$V_{BR}$	2(	I <sub>BR</sub> = 1 mA	10	_	_	V
I <sub>R</sub>		V <sub>RWM</sub> = 8 V	_	_	0.05	μA
V <sub>C</sub>	(Note 1)	ү <sub>РР</sub> = 1 А	_	18	_	V
R <sub>DYN</sub>	(Note 2)	$\downarrow$	_	2.5	—	Ω
Ct	(Note 3)	V <sub>R</sub> = 0 V, f = 1 MHz	_	0.3	0.5	pF
	V <sub>RWM</sub> V <sub>BR</sub> I <sub>R</sub> V <sub>C</sub> R <sub>DYN</sub>	V <sub>RWM</sub> V <sub>BR</sub> I <sub>R</sub> V <sub>C</sub> (Note 1)           R <sub>DYN</sub> (Note 2)	$V_{RWM}$ $V_{BR}$ $I_{BR} = 1 \text{ mA}$ $I_R$ $V_{RWM} = 8 \text{ V}$ $V_C$ $(Note 1)$ $I_{PP} = 1 \text{ A}$ $R_{DYN}$ $(Note 2)$	V <sub>RWM</sub> V <sub>BR</sub> I <sub>BR</sub> = 1 mA         10           I <sub>R</sub> V <sub>RWM</sub> = 8 V            V <sub>C</sub> (Note 1)         I <sub>PP</sub> = 1 A            R <sub>DYN</sub> (Note 2)	$V_{RWM}$ -         - $V_{BR}$ $I_{BR}$ = 1 mA         10         - $I_R$ $V_{RWM}$ = 8 V         -         -         - $V_C$ (Note 1) $I_{PP}$ = 1 A         -         18 $R_{DYN}$ (Note 2)         -         -         2.5	V <sub>RWM</sub> -         -         8           V <sub>BR</sub> I <sub>BR</sub> =1.mA         10         -         -           I <sub>R</sub> V <sub>RWM</sub> =8 V         -         -         0.05           V <sub>C</sub> (Note 1)         I <sub>PP</sub> =1 A         -         18         -           R <sub>DYN</sub> (Note 2)         -         -         2.5         -

Note 1: Based on IEC61000-4-5 8/20 µs pulse.

Note 2: TLP parameter: Z0 = 50  $\Omega$ , tp = 100 ns, tr = 300 ps, averaging window: t1 = 30 ns to t2 = 60 ns,

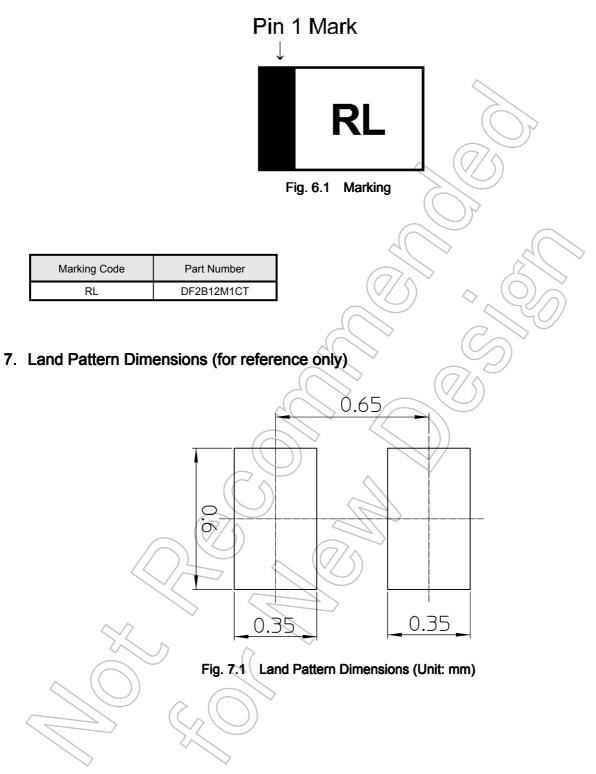
extraction of dynamic resistance using a least-squares fit of TLP characteristics at IPP between 3 A to 8 A.

Note 3: Guaranteed by design.

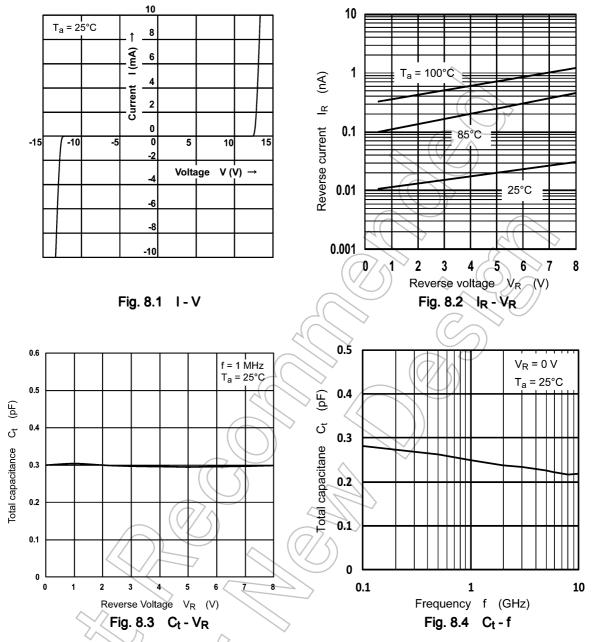
### 5. Guaranteed ESD Protection (Note)

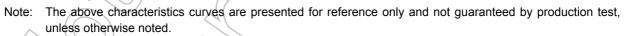
Test Condition	ESD Protection
IEC61000-4-2 (Contact discharge)	±8 kV
Note: Criterion: No damage to de	evices.

6. Marking



### 8. Characteristics Curves (Note)





### 9. Clamp Voltage V<sub>C</sub> - Peak Pulse Current (IPP) (Note)

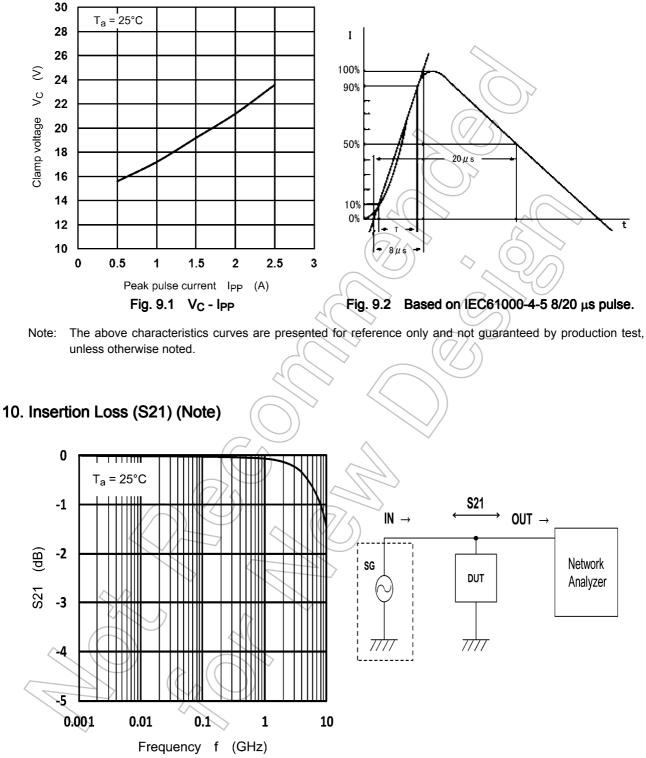
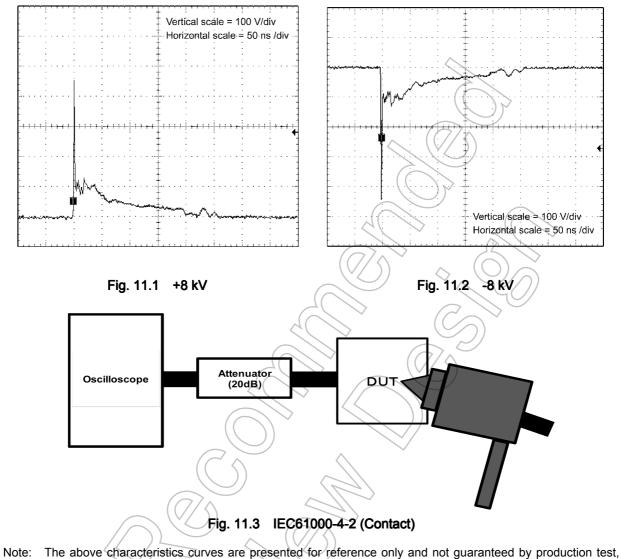


Fig. 10.1 S21 - f

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

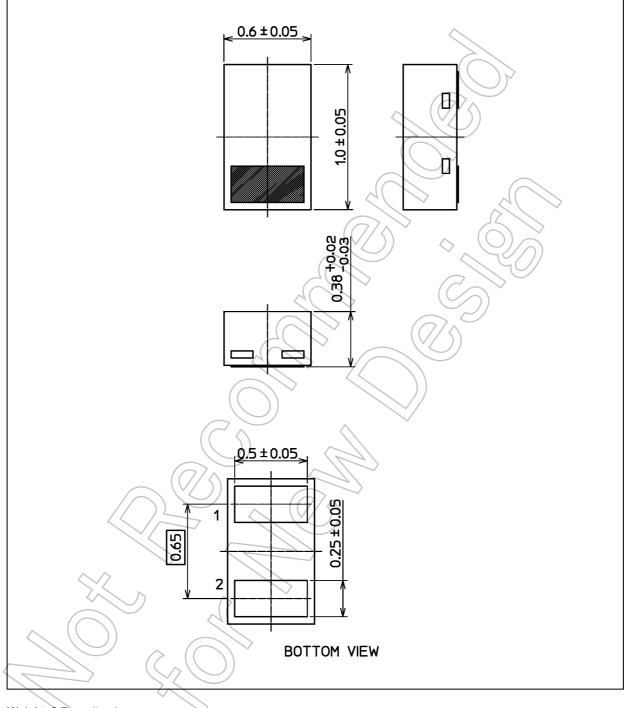
### 11. ESD Clamp Waveform (Note)



vote: The above characteristics curves are presented for reference only and not guarantee unless otherwise noted.

### Package Dimensions

Unit: mm



#### Weight: 0.7 mg (typ.)

	Package Name(s)
TOSHIBA: 1-1P1S	
Nickname: CST2	

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